Product Change Notification

The information below reflects a change that is being implemented.

09/14/2005 Notice Date: **Product Category:** Battery Management; Infrared Devices; Linear Devices; Mixed Signal Devices; Power Management; RS232; Supervisor; Thermal Management; CAN Communication; Infrared Communication; LIN Communication; Serial Communication; 24xxx; 25xxx; 93xxx; Other; PIC10xxx; PIC12xxx; PIC16xxx; PIC17xxx; PIC18xxx; rfPIC; RFID; SDP **Notification Subject:** Change #585 - QUALIFICATION OF 8L SOIC AT NEW ASSEMBLY SITE: VIGILANT, THAILAND **Notification Body:** Device(s): All 8 Pin SOIC Packaged Devices Description of Change: NEW SITE/PACKAGE QUALIFICATION Impacts to Data Sheet: NONE Reason for Change: **INCREASED CAPACITY** Estimated Change Implementation Date(s): NOVEMBER, 2005 Markings to Distinguish Revised From Unrevised Devices: (e.g.: Date Code, Device Marking, Ship Container Marking) TRACEABILITY CODE